



# SPP1015

## P-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPP1015 is the P-Channel enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching , low in-line power loss, and resistance to transients are needed.

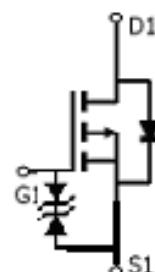
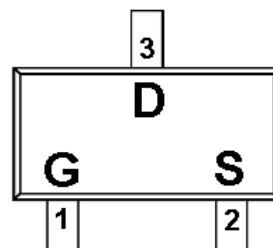
### FEATURES

- ◆ P-Channel
  - 20V/0.45A,R<sub>DS(ON)</sub>=520mΩ@V<sub>GS</sub>=-4.5V
  - 20V/0.35A,R<sub>DS(ON)</sub>=700mΩ@V<sub>GS</sub>=-2.5V
  - 20V/0.25A,R<sub>DS(ON)</sub>=1500mΩ@V<sub>GS</sub>=-1.8V
- ◆ Super high density cell design for extremely low R<sub>DS (ON)</sub>
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-523 (SC-89) package design

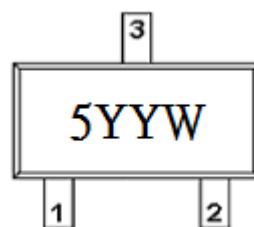
### APPLICATIONS

- Drivers : Relays/Solenoids/Lamps/Hammers
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

### PIN CONFIGURATION( SOT-523 / SC-89 )



### PART MARKING



Y : Year Code  
W : Week Code



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### PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPP1015S52RG	SOT-523	5Y
SPP1015S52RGB	SOT-523	5Y

- ※ SPP1015S52RG : Tape Reel ; Pb – Free
- ※ SPP1015S52RGB : Tape Reel ; Pb – Free, Halogen – Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-20	V
Gate –Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current(T <sub>J</sub> =150°C)	T <sub>A</sub> =25°C	ID	A
	T <sub>A</sub> =70°C		
Pulsed Drain Current	I <sub>DM</sub>	-3	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	-0.6	A
Power Dissipation	T <sub>A</sub> =25°C	P <sub>D</sub>	W
	T <sub>A</sub> =70°C		
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	T ≤ 10sec	R <sub>θJA</sub>	°C/W
	Steady State		
		360	
		400	



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### ELECTRICAL CHARACTERISTICS

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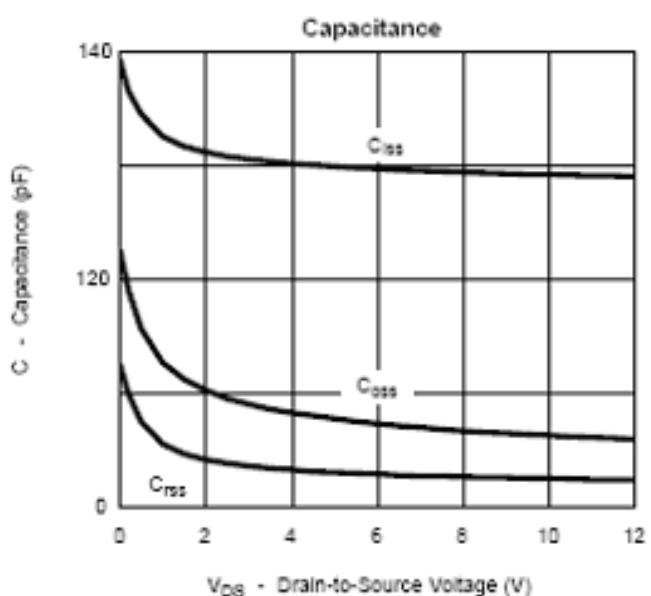
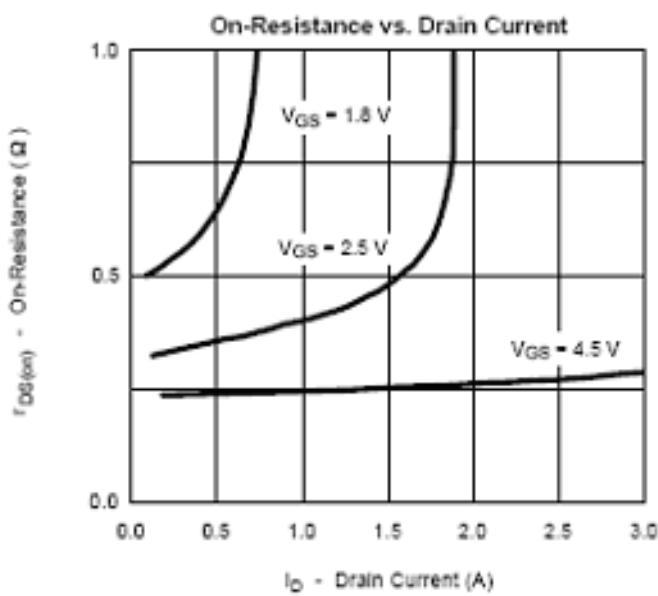
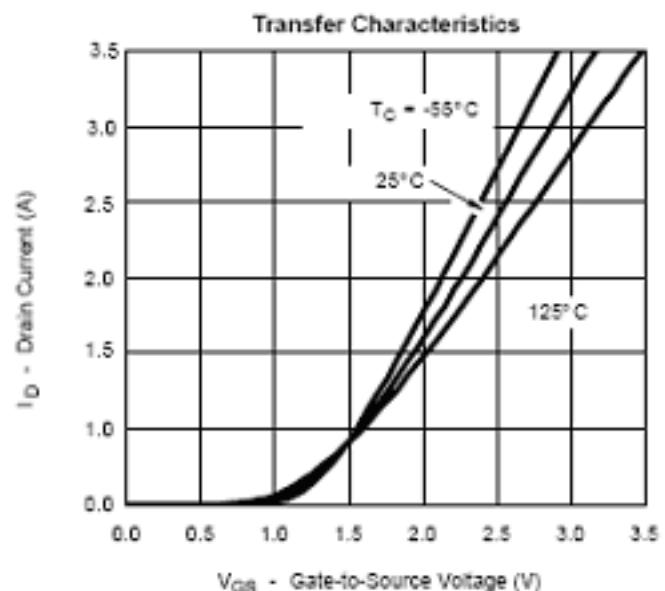
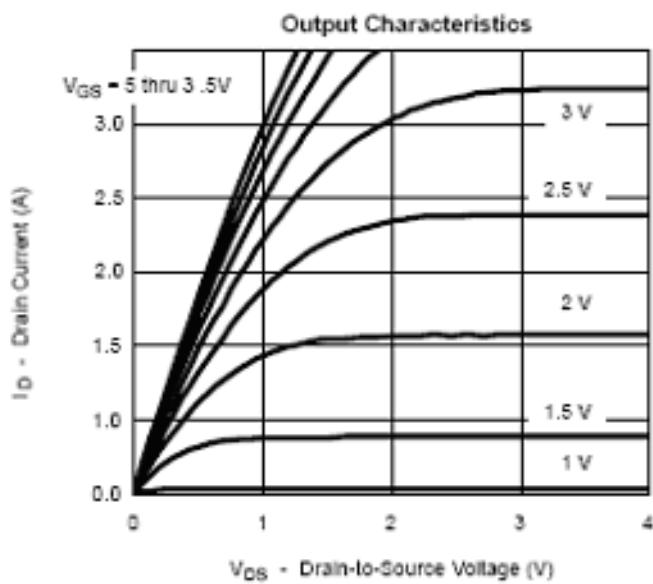
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID=-250uA	-20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , ID=-250uA	-0.35		-1.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±10	uA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V			-1	uA
		V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			-5	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≤ -4.5V, V <sub>GS</sub> =-5V	-2			A
Drain-Source On-Resistance	R <sub>D(on)</sub>	V <sub>GS</sub> =-4.5V, ID=-0.45A		0.42	0.52	Ω
		V <sub>GS</sub> =-2.5V, ID=-0.35A		0.58	0.70	
		V <sub>GS</sub> =-1.8V, ID=-0.25A		0.95	1.5	
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =-10V, ID=-1.0A		1.5		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-0.5A, V <sub>GS</sub> =0V		-0.8	-1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-10V, V <sub>GS</sub> =-4.5V ID=-0.88A		1.5	2.0	nC
Gate-Source Charge	Q <sub>gs</sub>			0.3		
Gate-Drain Charge	Q <sub>gd</sub>			0.2		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V f=1MHz		145		pF
Output Capacitance	C <sub>oss</sub>			25		
Reverse Transfer Capacitance	C <sub>rss</sub>			10		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-10V, R <sub>L</sub> =20Ω , ID=-0.5A V <sub>GEN</sub> =-4.5V , R <sub>G</sub> =6Ω		18	30	ns
	t <sub>r</sub>			25	40	
Turn-Off Time	t <sub>d(off)</sub>			15	45	
	t <sub>f</sub>			12	20	



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### TYPICAL CHARACTERISTICS

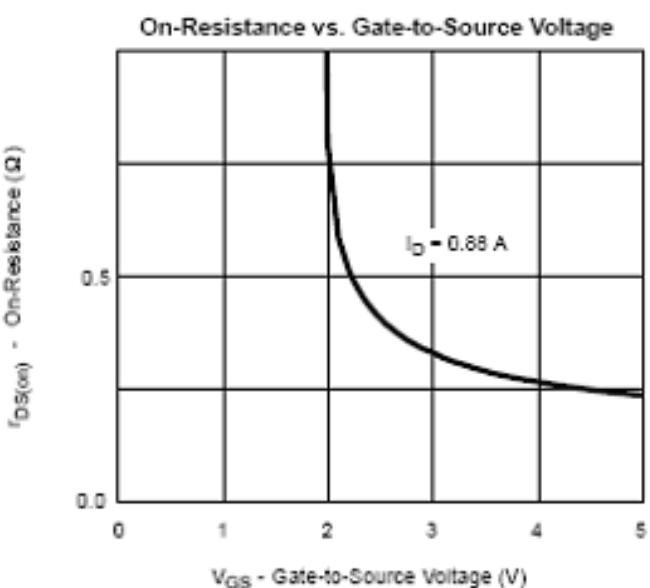
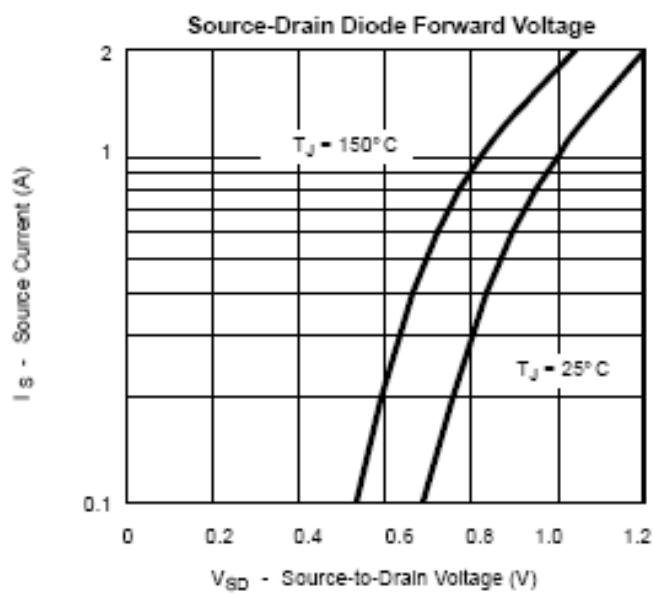
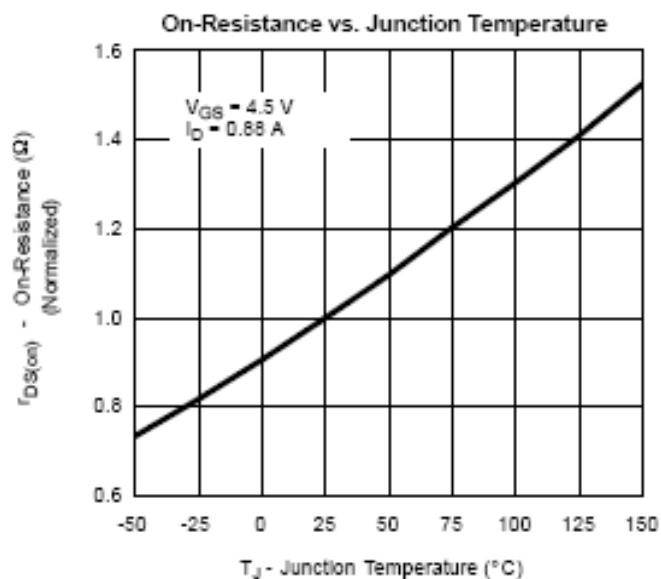
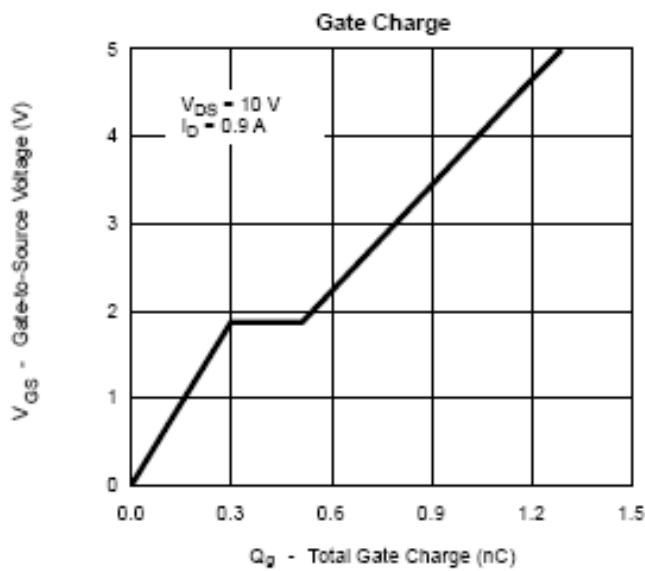




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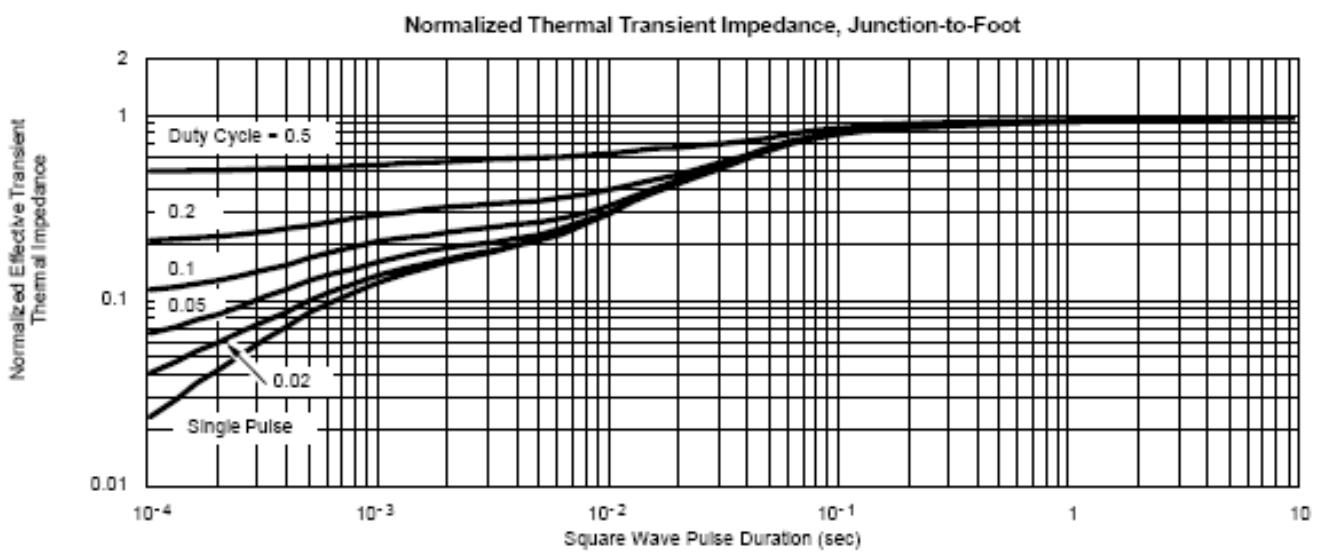
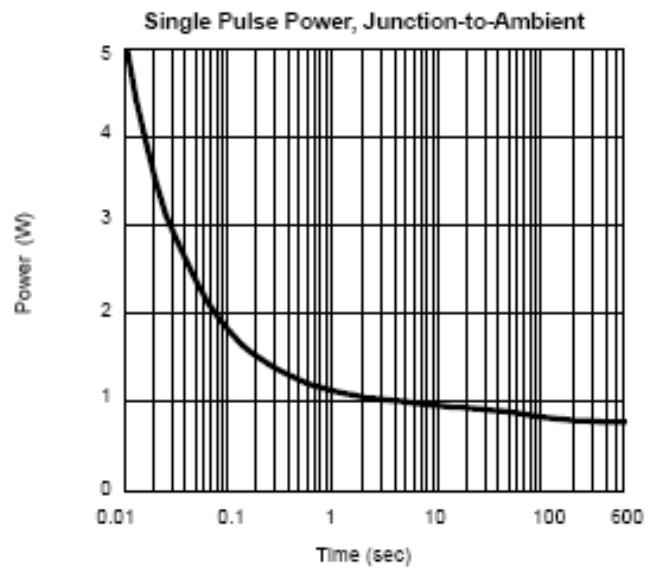
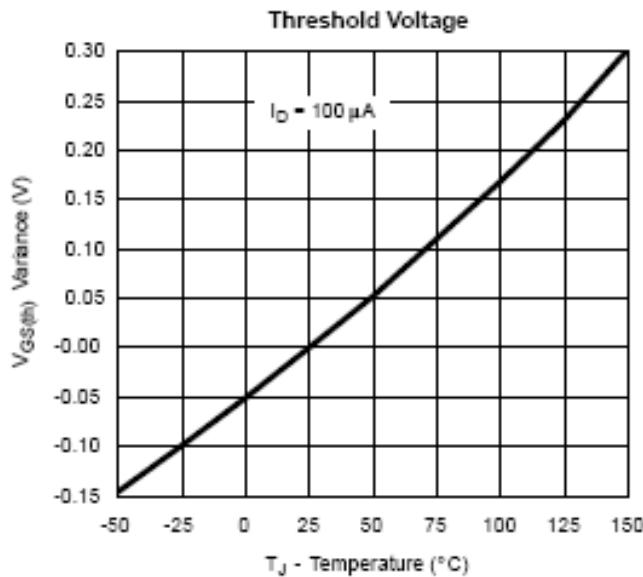




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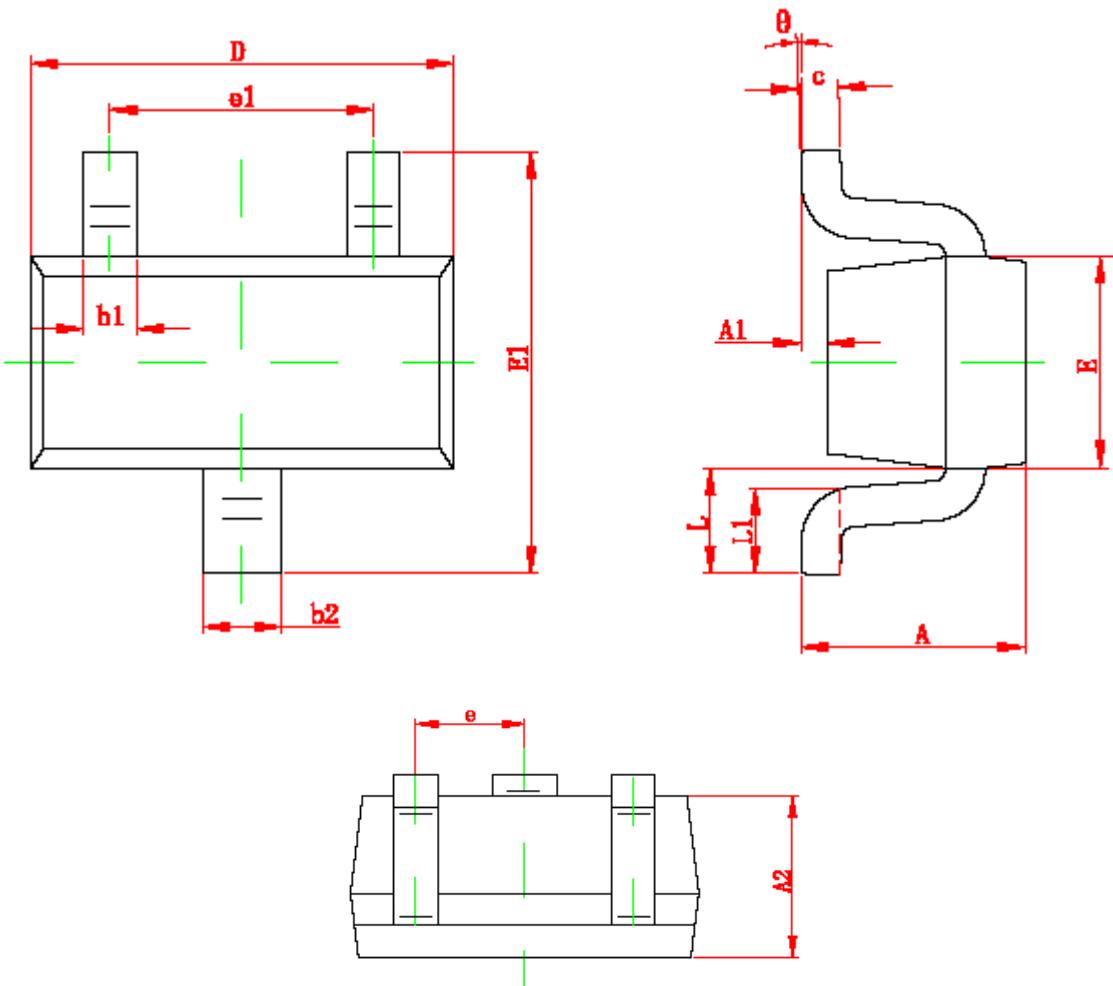




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### SOT-523 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.325	0.010	0.013
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.750	0.850	0.030	0.033
E1	1.450	1.750	0.057	0.069
e	0.500 TYP		0.020 TYP	
e1	0.900	1.100	0.035	0.043
L	0.550 REF		0.022 REF	
L1	0.280	0.440	0.011	0.017
θ	0°		4°	



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SYNC Power Corporation  
7F-2, No.3-1, Park Street  
NanKang District (NKSP), Taipei, Taiwan 115  
Phone: 886-2-2655-8178  
Fax: 886-2-2655-8468  
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